

30V Dual P-Channel Enhancement MOSFET

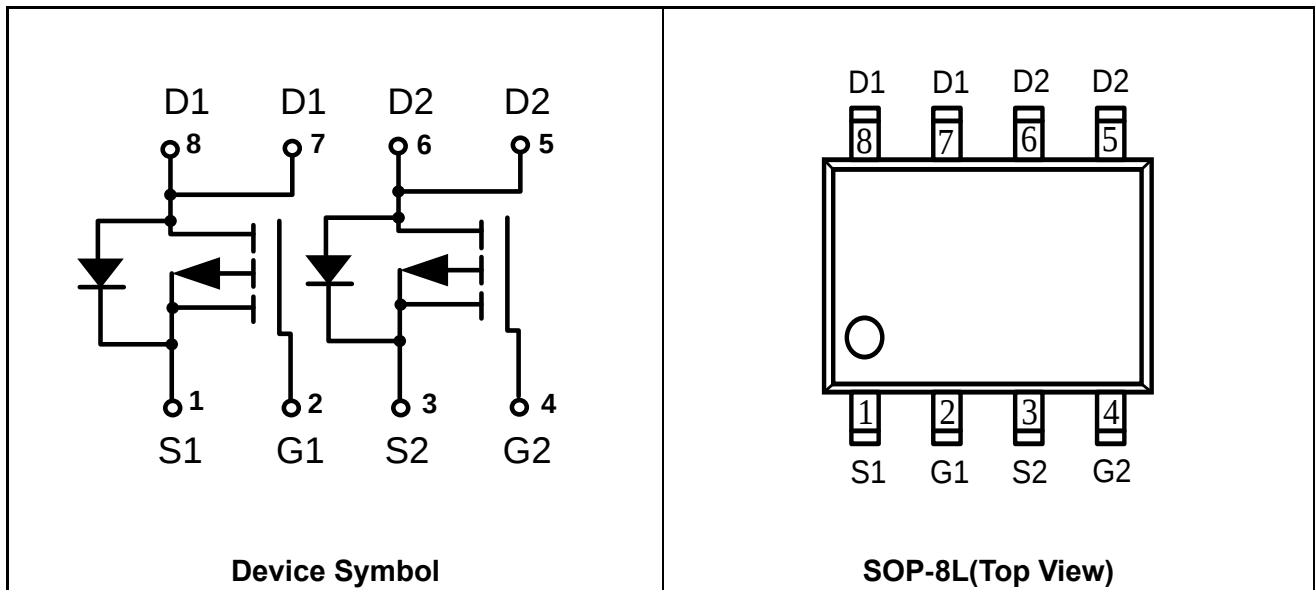
Features

- $V_{DS} = -30V$, $I_D = -5A$
 $R_{DS(on)} < 60m\Omega$ @ $V_{GS} = -10V$
 $R_{DS(on)} < 90m\Omega$ @ $V_{GS} = -4.5V$
- Trench Power LV MOSFET Technology

Mechanical Characteristics

- SOP-8L Package
- Marking : Making Code
- RoHS Compliant

Schematic & PIN Configuration



EM03DP50A

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	-5	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	-20	A
Total Power Dissipation		P_D	2.3	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient ⁽²⁾	$R_{\theta JA}$	54.3	$^\circ\text{C/W}$

EM03DP50A

Electrical Characteristics (T_J = 25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	B _{VDSS}	V _{GS} = 0V, I _D = -250μA	-30	-	-	V
Gate-body Leakage current	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -30V, V _{GS} = 0V	-	-	-1	μA
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.0	-1.5	-2.1	V
Drain-Source On-Resistance ⁽³⁾	R _{DS(on)}	V _{GS} = -10V, I _D = -4.1A	-	42	60	mΩ
		V _{GS} = -4.5V, I _D = -3A	-	57	90	
Dynamic Characteristics ⁽⁴⁾						
Input Capacitance	C _{iSS}	V _{DS} = -15V, V _{GS} =0V, f =1MHz	-	530	-	pF
Output Capacitance	C _{oSS}		-	70	-	
Reverse Transfer Capacitance	C _{rSS}		-	56	-	
Switching Characteristics ⁽⁴⁾						
Total Gate Charge	Q _g	V _{GS} = -10V,I _D = -4.1A, V _{DS} = -15V	-	10	-	nC
Gate-Source Charge	Q _{gs}		-	2	-	
Gate-Drain Charge	Q _{gd}		-	2.8	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = -10V , V _{DD} = -15V, R _G = 6Ω, I _D = -4.1A,	-	6.9	-	ns
Rise Time	t _r		-	12	-	
Turn-Off Delay Time	t _{d(off)}		-	19	-	
Fall Time	t _f		-	7.5	-	
Source-Drain Body Diode Characteristics						
Diode Forward Voltage ⁽³⁾	V _{SD}	I _S = -1.7A, V _{GS} = 0V	-	-	-1.2	V
Continuous Source Current	I _S		-	-	-5	A

Note1: Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C

Note2: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.

Note3: Pulse Test: Pulse width≤300μs, duty cycle≤2%.

Note4: This value is guaranteed by design hence it is not included in the production test.

EM03DP50A

Typical Characteristics

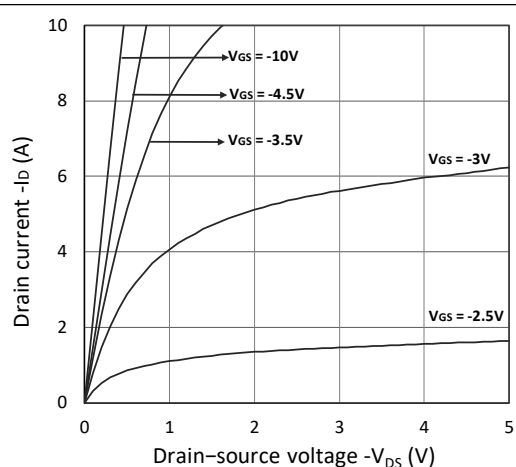


Figure 1. Output Characteristics

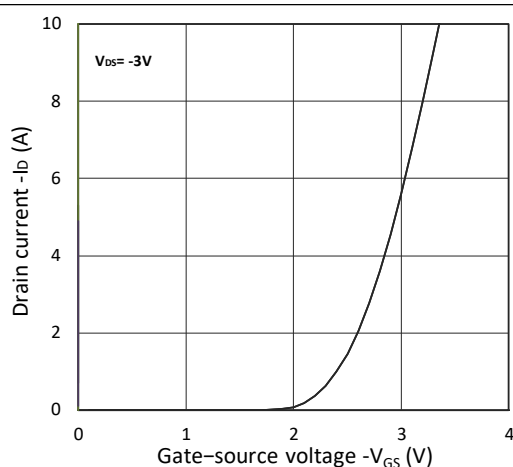


Figure 2. Transfer Characteristics

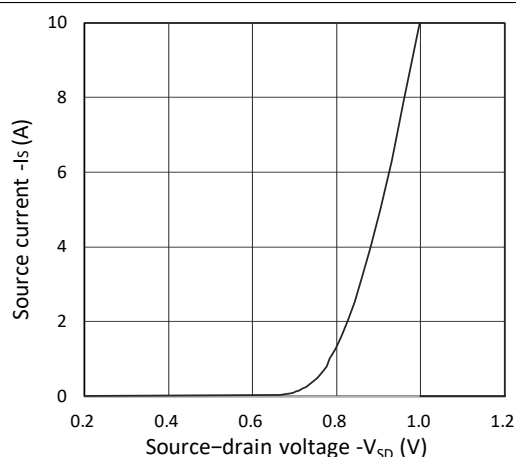


Figure 3. Forward Characteristics of Reverse

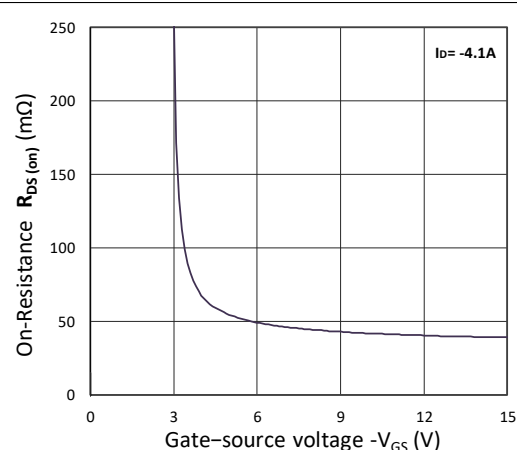


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

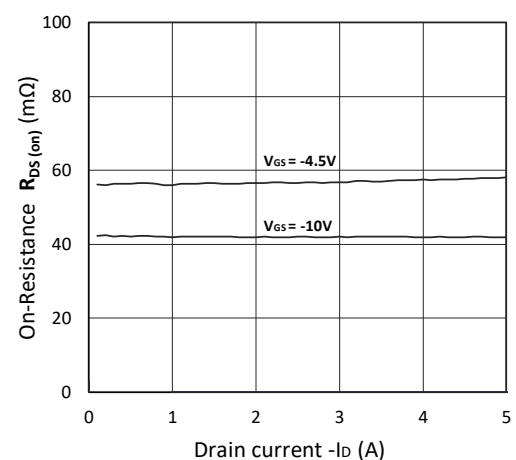


Figure 5. $R_{DS(ON)}$ vs. I_D

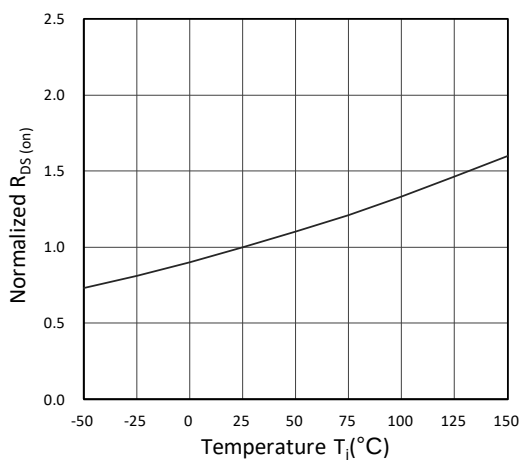


Figure 6. Normalized $R_{DS(ON)}$ vs. Temperature

EM03DP50A

Typical Characteristics(Continued)

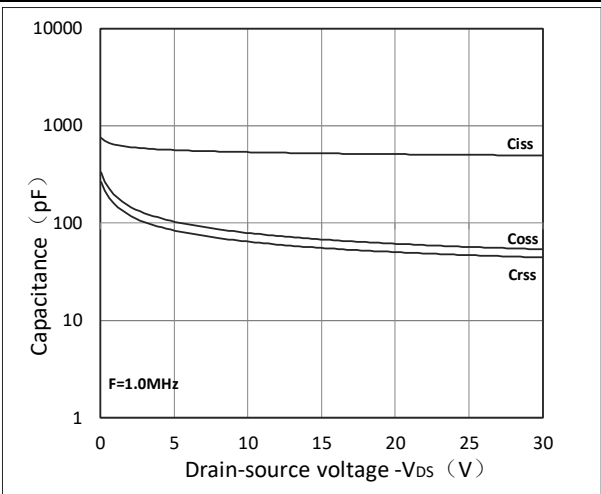


Figure 7. Capacitance Characteristics

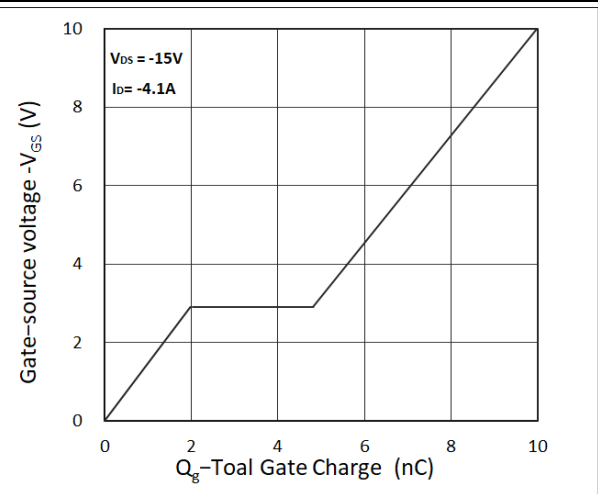


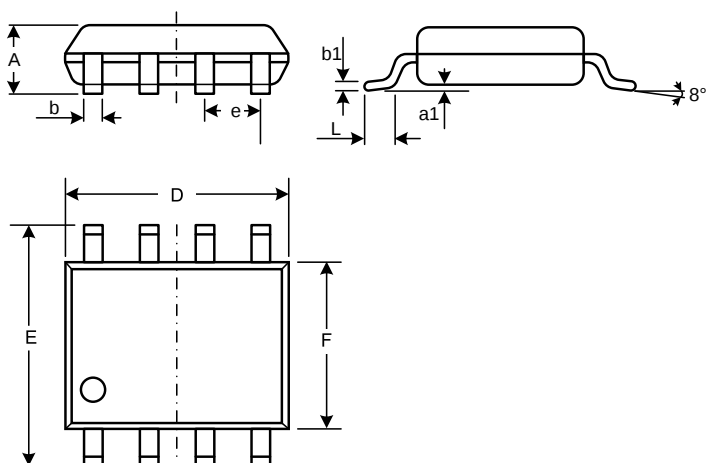
Figure 8. Gate Charge Characteristics

EM03DP50A

Package Dimension

SOP-8L

PACKAGE OUTLINE



SYMBOL	MILLIMETER	
	MIN	MAX
A	1.35	1.75
a1	0.05	0.25
b	0.31	0.51
b1	0.16	0.25
D	4.70	5.15
E	5.75	6.25
e	1.07	1.47
F	3.70	4.10
L	0.40	1.27

EM03DP50A

Ordering Information

Part	Package	Marking	Packing Information
EM03DP50A	SOP-8L	4953	4k/Reel

Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
1.0	2018-08-07	Released Version	Qi Shu Kun	Qi Shu Kun	Liu Jia Ying